

COMPACT HIGH POWER RELAY 1 POLE - 30A (28VDC) (For 24V battery automotive applications)

FBR57 Series

FEATURES

- High power contact capacity (carrying current: 40 A/10 minutes, 30 A/1 hour)
- Suitable for controlling 24 V motors in trucks and other large vehicles
- High heat resistance and extended operating voltage
- Contact gap 0.8mm
- RoHS compliant Please see page 6 for more information



PARTNUMBER INFORMATION

	FBR57	N	D24	-	W1	-	**
[Example]	(a)	(b)	(c)		(d)		(e)

(a)	Relay type	FBR57	: FBR57 Series
(b)	Enclosure	N	: Plastic sealed type
(c)	Coil rated voltage	D24	: 24 VDC Coil rating table at page 2
(d)	Contact material	W1 Y	: Silver-tin oxide indium : Silver-tin oxide
(e)	Special type	To be assigned custom specification	

Actual marking does not carry the type name: "FBR" E.g.: Ordering code: FBR57ND24-W1 Actual marking: 57ND24-W1

■ SPECIFICATION

Item			FBR57		
Contact Data	Configuration		1 form C		
	Material		Silver-tin oxide indium (-W1 type) Silver-tin oxide (-Y type)		
	Voltage drop		Max. 100 mV at 1A, 12VDC		
	Contact rating		28VDC, 12A (locked motor load) 28VDC, Inrush 15A, break 2.5A (motor free load)		
	Max. carrying current		40A/10 minutes, 30A/1 hour (25 °C, 100% rated coil voltage)		
	Max. inrush current		70A (reference)		
	Max. switching voltage		28VDC (reference)		
	Max. switching current		12A (reference)		
	Min. switching load *		6 VDC, 1A		
Life	Mechanical		Min. 10 x 10 ⁶ operations		
	Electrical		Min. 100×10^3 operations (locked motor load) Min. 500×10^3 operations (motor free load)		
Coil Data	Operating temperature range		-40 °C to +85 °C (no frost)		
	Storage temperature range		-40 °C to +100 °C (no frost)		
Timing Data	Operate (at nominal voltage)		Max. 10 ms		
	Release (at nominal voltage)		Max. 5 ms		
Other	Vibration resistance	Misoperation	10 to 200Hz, acceleration 44m/s² (4.5G), constant acceleration		
		Endurance	10 to 200Hz, acceleration 44m/s² (4.5G), constant acceleration		
	ChI.	Misoperation	100m/s²		
	Shock	Endurance	1,000m/s²		
	Weight		Approximately 9.4 g		

^{*} Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels

Note: Care shall be taken on the heat generated on PC board when maximum carrying current exceeds 10A. Please perform the confirmation test with actual conditions.

COIL RATING

Coil Code	Rated Coil Volt- age (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC)*
D24	24	384	14.4 (at 20 °C)	1.9 (at 20 °C)
			18 (at 85 °C)	2.4 (at 85 °C)

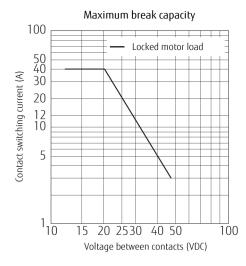
Note: All values in the table are valid for 20°C and zero contact current, unless otherwise stated.

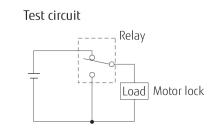
Note: Please use at rated coil voltage. Please refer to characteristic data and set up adequate voltage in case of use

^{*} Specified operate values are valid for pulse wave voltage.

■ CHARACTERISTIC DATA

(Characteristic data is not guaranteed value but measured values of samples from production line.)



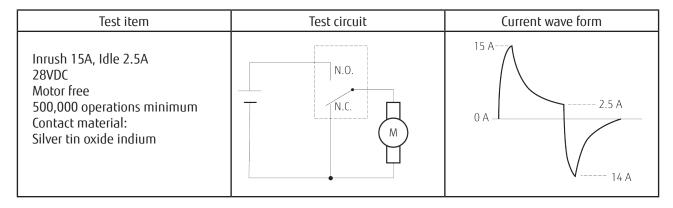


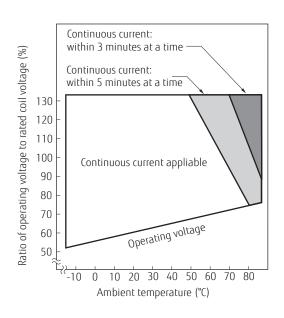
Life test (example)

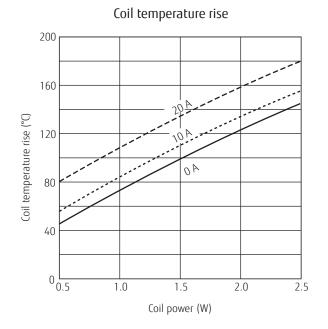
(1) Motor lock

Test item	Test circuit	Current wave form		
12A, 28VDC Motor lock 100,000 operations minimun Contact material: Silver tin oxide indium	(RL-1) N.O. N.C. N.C. (RL-2)	(RL-1) 12 A 0 A (RL-2) 12 A 0 A		

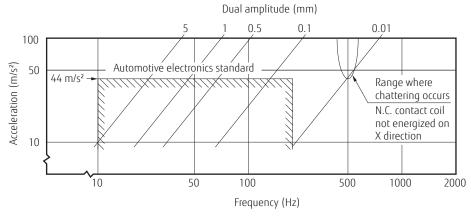
(2) Motor free



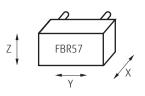




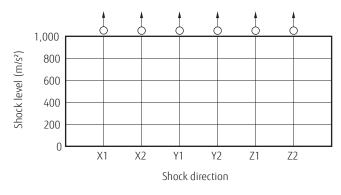
Vibration resistance characteristics



Frequency: 10 ~ 2000Hz Acceleration: 100m/s² max. Direction of vibration: See diagram below Detection level: Chatter >1ms

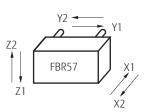


Shock resistance characteristics

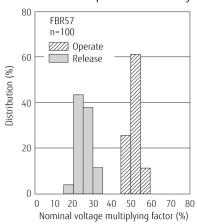


O All directions: Min. 1,000m/s²

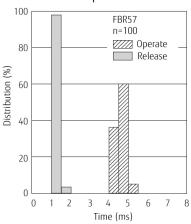
Shock application time: 6±1ms, half-sine wave Test conditions: Coil energized and de-energized Shock direction: See diagram below Detection level: Chatter >1ms



Distribution of operate/release voltage



Distribution of operate/release time



Terminal No.1, 2 0.5 ^t x 1.2 ^w Terminal No. 3, 4

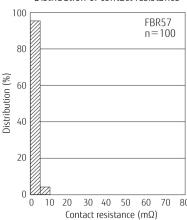
 $0.3^{t} \times 1.0^{w}$

Terminal No. 5, 6

 $0.3^{t} \times 1.2^{w}$

(3.9)

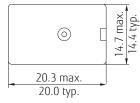
Distribution of contact resistance



DIMENSIONS

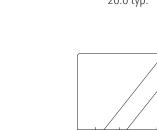
Dimensions

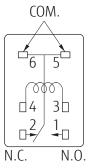
16.2 typ.



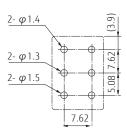
7.62

Schematics (BOTTOM VIEW)





PC board mounting hole layout (BOTTOM VIEW)



- * Dimensions of the terminals do not include thickness of pre-solder.
- * Tolerance of PC board mounting hole layout : ±0.1 unless otherwise specified.
- * Dimensions do not include tolerances. Please ask specification in case you need tolerances.

() : Reference Unit: mm

Cautions

- All values mentioned in this datasheet are provided under ideal conditions. Please perform the confirmation test before actual use.
- Reflow soldering is prohibited for standard type.
- Do not use relays in the atmosphere with sulfide gas, chloride gas or nitric oxide. Contact resistance may increase.
- Do not use silicon or silicon-containing product or materials near relays. It may cause contact failure.

RoHS Compliance and Lead Free Information

1. General Information

- All relays produced by Fujitsu Components are compliant with RoHS directive 2011/65/EU including amendments.
- Cadmium as used in electrical contacts is exempted from the RoHS directives.
 As per Annex III of directive 2011/65/EU.
- All relays are lead-free. Please refer to Lead-Free Status Info for older date codes at: http://www.fujitsu.com/downloads/MICRO/fcai/relays/lead-free-letter.pdf
- Lead free solder plating on relay terminals is Sn-3.0Ag-0.5Cu, unless otherwise specified. This material has been verified to be compatible with PbSn assembly process.

2. Recommended Lead Free Solder Condition

• Recommended solder Sn-3.0Ag-0.5Cu.

Flow Solder Condition:

Pre-heating: maximum 120°C

within 90 sec.

Soldering: dip within 5 sec. at

255°C ± 5°C solder bath

Relay must be cooled by air immediately

after soldering

Solder by Soldering Iron:

Soldering Iron 30-60W

Temperature: maximum 350-360°C Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

Moisture Sensitivity Level standard is not applicable to electromechanical relays, unless otherwise indicated.

4. Tin Whiskers

• Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.

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